

**Amendments to the Claims:**

The following listing of claims will replace all prior versions, and listings, of claims in the application:

1. (Original) A liquid composition comprising at least diamond fine particles, a dispersant and an amine substance.
2. (Currently Amended) The liquid composition of claim 1 ~~or~~ 2, wherein said amine substance has a boiling point of 50 °C or higher and 300 °C or lower.
3. (Currently Amended) The liquid composition of claim 1 ~~or~~ 2, wherein said dispersant comprises water, a water soluble dispersant or a mixture of water and a water soluble dispersant.
4. (Currently Amended) A low dielectric constant film obtained by applying said liquid composition of ~~any one of~~ claims 1 ~~to~~ 3.
5. (Original) An electronic component comprising said low dielectric constant film of claim 4.
6. (Currently Amended) An abrasive comprising diamond fine particles, said abrasive obtained from said liquid composition of ~~any one of~~ claims 1 ~~to~~ 3.
7. (Original) A method of producing a liquid composition of diamond fine particles, said method comprising the steps of:  
heating coarse diamond fine particles in a solution comprising a purifying agent;

washing said fine particles with water; and

dispersing said fine particles under the presence of an amine substance.

8. (Original) The method of claim 7, wherein said purifying agent comprises sulfuric acid.

9. (New) The liquid composition of claim 2, wherein said dispersant comprises water, a water soluble dispersant or a mixture of water and a water soluble dispersant.

10. (New) A low dielectric constant film obtained by applying said liquid composition of claim 2.

11. (New) A low dielectric constant film obtained by applying said liquid composition of claim 3

12. (New) An abrasive comprising diamond fine particles, said abrasive obtained from said liquid composition of claim 2.

13. (New) An abrasive comprising diamond fine particles, said abrasive obtained from said liquid composition of claim 3.